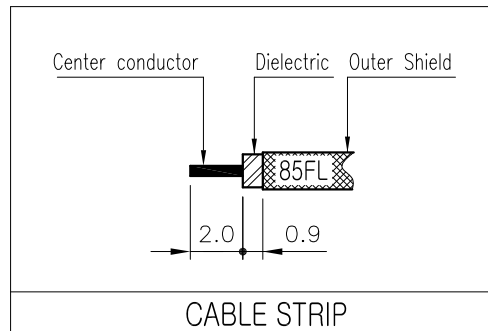
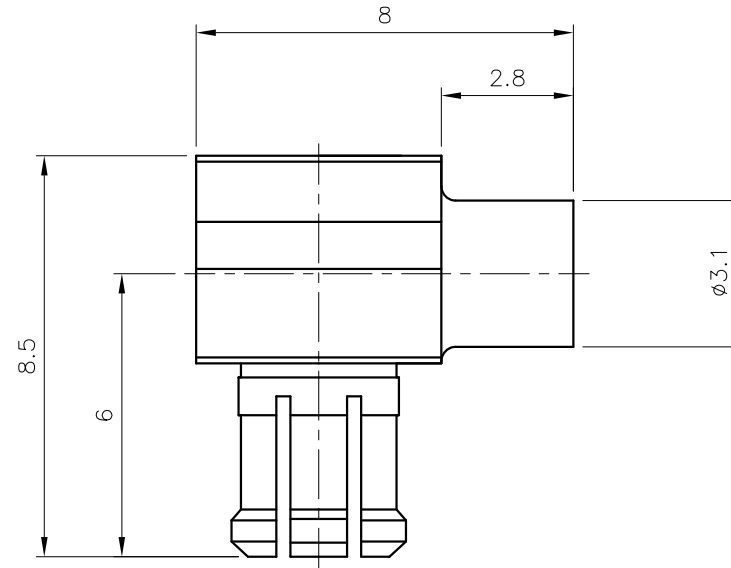


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1A	Initial Registration	E.H.KIM	I.C.KIM	2013.04.22.
i	[설번No.201912-0010] 생산성 향상 절면체 형상 변경 및 Jack 낙시바늘 추가	S.Y.EUN	I.C.KIM	2019.12.23.



5	COVER	1	MBsBD KS D 5101 C3604	Gold Plate 0.5μm	DCO00013-5/4
4	INSULATOR	1	TEFLON		DIN00933-N/1
3	INSULATOR	1	TEFLON		DIN00065-N/2 DIN00065-N/1
2	CONTACT	1	MBsBD KS D 5101 C3604	Gold Plate 1.27μm	DCT00069-5/2
1-2	JACK BODY	1	BeCu KS D 5102 C1720	Gold Plate 0.5μm	DJA00010-4/4
1-1	BODY	1	MBsBD KS D 5101 C3604		DBB00326-5/2 DBD03204-1/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2019. 12. 26.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY					
MATERIAL _____		CHECKED BY			TITLE MCX50 CABLE PL 85		
		DRAWN BY I.C.KIM					
FINISH _____	SCALE 6/1	UNIT mm			A4	DWG NO. CN00034-7/3	
						REVISION 1	SHEET 1 of 1